

Low-Power Low-Jitter MEMS Oscillators

Features

- Any Frequency Between:
 - 2.3 MHz to 170 MHz (2.5V and 3.3V)
 - 2.3 MHz to 125 MHz (1.8V)
- Exceptional Total Stability Over Temperature ±20 ppm, ±25 ppm, ±50 ppm
- Low Phase Jitter (1 ps Typical)
- Operating Voltage 1.8V/2.5V to 3.3V
- Standby Mode for Battery Life Saving
- Fast Startup Time (2.5 ms Typical)
- Extended Temperature Range: -40°C to +125°C
- Low Operation Current (6.5 mA Typical)
- Ultra-Small Footprints:
 - 2.0 mm x 1.6 mm LGA Package
 - 2.5 mm x 2.0 mm LGA Package
 - 7.0 mm x 5.0 mm DFN Package
- High Reliability: 20x Better MTF than Quartz Oscillators
- MIL-STD 883 Shock and Vibration Resistant
- · Lead-Free and RoHS-Compliant

Applications

- USB, SATA, SAS Reference Clock
- 100M/1G/10G Ethernet Clock
- IP Cam, DVR, OTT-Box
- Storage/SSD
- IoT Terminal/Gateway

Benefits

- Pin for Pin "Drop-In" Replacement for Industry Standard Oscillators
- Semiconductor-Level Reliability, Significantly Higher than Quartz
- Short Production Lead Time
- Longer Battery Life/Reduced Power Consumption
- Compact Plastic Package
- Cost Effective

General Description

The DSC1501/2/3/4/5 and DSC1521/2/3/4/5 are industry-leading MEMS oscillators that offer excellent jitter and stability performance at very low power over a wide range of supply voltage (1.71V to 3.63V) and temperature (-40° C to +125°C). The devices operate from 2.3 MHz to 170 MHz with 2.5V and 3.3V supply voltage and from 2.3 MHz to 125 MHz with 1.8V supply voltage.

The devices incorporate an all-silicon resonator that is extremely robust. A MEMS-based design allows for a higher level of reliability, making the DSC150x/DSC152x ideal for rugged, industrial, and portable applications where stress, shock, and vibrations can damage quartz crystal-based systems. The devices are also an excellent choice as clock reference for small, battery-operated devices, such as wearables and Internet-of-Things (IoT) devices.

Available in industry standard packages, the DSC150x/DSC152x can be a drop-in replacement to standard crystal oscillators.

Package Type



Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings ^{† ††}

Supply Voltage (V _{CC})	–0.3V to +4.0V
LVTTL Input Voltage	–0.3V to V _{DD} + 0.3V
ESD Protection (HBM)	
ESD Protection (MM)	
ESD Protection (CDM)	

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

†† Notice: The data sheet limits are not guaranteed if the device is operated beyond the recommended operating conditions.

ELECTRICAL CHARACTERISTICS

Electrical Characteristics: $V_{DD} = 1.8V + 10\% / -5\%$, $V_{DD} = 2.5V \pm 10\%$, $V_{DD} = 3.3V \pm 10\%$; $T_A = -40$ °C to +125°C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
Supply Voltage	V	2.25		3.63	V	Note 1, DSC150	01/2/3, DSC1521/2/3	
Supply vollage	VDD	1.71	_	1.98	v	Note 1, DSC150)4/5, DSC1524/5	
Power Supply Ramp	t _{PU}	0.1	_	100	ms	Note 2		
Supply Current		—	6.5	7.5	٣A	f ₀ = 20 MHz, V _{DD} = 3.3V, no load, outpu enabled		
	DD	_	6.5	7.8	ШA	f _{VCO} = 141.249 I load, output disa	MHz, V _{DD} = 3.3V, no abled	
Standby Current	1	—	1	—		V _{DD} = 1.8V/2.5V	1	
Standby Current	STDBY_	—	1.8	—	μΑ	V _{DD} = 3.3V		
	V _{IH}	$0.7 \mathrm{x} \mathrm{V}_\mathrm{DD}$		—	V	Input logic High,	Note 3	
Input Logic Levels	V _{IL}	—		$0.3 \times V_{DD}$	v	Input logic Low,	Note 3	
	V _{OH}		_	—	V	I _{OH}	= -16 mA, Std. drive	
		0.8 x V _{DD}		_		V _{DD} = 3.3V I _{OH}	= –12 mA, Medium drive	
			_	—		I _{OH}	= –6 mA, Low drive	
			_	—		I _{OH}	= -10 mA, Std. drive	
Output Logic Levels			_	—		V _{DD} = 2.5V I _{OH}	= –6 mA, Medium drive	
			_	—		I _{ОН}	= -3 mA, Low drive	
				—		$V_{} = 1.8V$	= –4 mA, Standard drive	
				—		VDD - 1.0V	= –2 mA, Low drive	
						I _{OL}	= 16 mA, Standard drive	
						V _{DD} = 3.3V I _{OL}	= 12 mA, Medium drive	
						I _{OL}	= 6 mA, Low drive	
Output Logic Levels	Vai			02xV	V	I _{OL}	= 10 mA, Standard drive	
Output Logic Levels	V OL	—	_	0.2 × 000	v	V _{DD} = 2.5V I _{OL}	= 6 mA, Medium drive	
						I _{OL}	= 3 mA, Low drive	
		—	_			$V_{} = 1.8V$	= 4 mA, Standard drive	
			_			I _{OL}	= 2 mA, Low drive	
Output Duty Cycle	—	47	_	53	%	_		

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: V_{DD} = 1.8V +10%/–5%, V_{DD} = 2.5V ±10%, V_{DD} = 3.3V ±10%; T_A = -40°C to +125°C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
		2.3	—	170		Standard drive	V _{DD} = 3.3V	
		2.3	_	125]	Medium drive	and V _{DD} = 2.5V	
Frequency	f ₀	2.3	_	50	MHz	Low drive		
		2.3	_	125		Standard drive	V _{DD} = 1.8V	
		2.3	—	60		Low drive		
		_	±20	_				
Frequency Stability	Δf	_	±25	_	ppm	All temperat	ture ranges	
		_	±50	_				
Aging	٨f	_	±5	_	nnm	First year @) 25°C	
Aging		_	±1	_	ppm	Per year aft	er first year	
Startup Time	t _{SU}	_	2.5	_	ms	From 90% V toggling	$V_{ m DD}$ until the output starts	
Output Disable Time	t _{ODs}	_	15	_	ns	From OE to	ggle to output OFF	
Output Enchlo Time	t _{ENOE}		_	1	μs	Pin 1 configured as OE		
	t _{ENST}	_	—	2	ms	Pin 1 configured as Standby		
Enable Pull-up Resistor	_	70	_	_	kΩ	Pull-up resistor at pin 1		
		_	1.4/1.3	_		V _{DD} = 1.8V	DSC1505, Std drive 20%-80%, C _L = 10 pF	
			1.1/1.0			V _{DD} = 2.5V	DSC1502, Std drive	
			1.2/1.0			V _{DD} = 3.3V	20%-80%, C _L = 10 pF	
Output Transition Time	t _R /t _F	_	3.0/2.4	_	ns	V _{DD} = 1.8V	DSC1504, Low drive 20%-80%, C _L = 10 pF	
			1.9/1.7			V _{DD} = 2.5V	DSC1501, Med drive	
			1.4/1.1			V _{DD} = 3.3V	20%-80%, C _L = 10 pF	
		_	4.5/4.1			V _{DD} = 2.5V	DSC1503, Low drive	
			3.4/2.9			V _{DD} = 3.3V	20%-80%, C _L = 10 pF	
Ovala ta Ovala littar		_	40	_		V _{DD} = 1.8V		
(Peak)	J _{CC}	_	18	_	ps	V _{DD} = 2.5V	f _{OUT} = 25 MHz	
		—	15	_		V _{DD} = 3.3V		
		_	6			V _{DD} = 1.8V		
Period Jitter, RMS	J _{PER}		2.5		ps	V _{DD} = 2.5V	f _{OUT} = 25 MHz	
			2.5			V _{DD} = 3.3V		
Deviced little a		_	45			V _{DD} = 1.8V		
(Peak-to-Peak)	J _{PP}		20	_	ps	V _{DD} = 2.5V	f _{OUT} = 25 MHz	
			18			V _{DD} = 3.3V		
Integrated Phase Noise	J _{PH}	_	1	_	ps _{RMS}	f _{OUT} = 100 MHz	12 kHz to 20 MHz, V _{DD} = 3.3V	

Note 1: V_{DD} pin should be filtered with a 0.1 μ F capacitor.

2: Time to reach 90% of target V_{DD} . Power ramp must be monotonic.

3: Input waveform must be monotonic with rise/fall time < 10 ms.

TEMPERATURE SPECIFICATIONS

Parameters	Symbol	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Operating Ambient Temperature Range	T _A	-40	—	+125	°C	—
Junction Operating Temperature	TJ	_	—	+125	°C	Note 1
Storage Temperature Range	Τ _S	-55	—	+150	°C	—
Lead Temperature	—	_	+260		°C	Soldering, 20 sec.

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, Ψ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1:PIN FUNCTION TABLE

Pin Number	Pin Name	Description
4	OE	Output Enabled: H = Output buffer Enabled, L = Disabled (High impedance): External pull-up recommended for normal operation.
I	STB	Standby: H = Device is active, L = Device is in Standby (Both output buffer and PLL disabled): External pull-up recommended for normal operation.
2	GND	Ground
3	OUT	Oscillator clock output
4	VDD	Power Supply: 1.71V to 3.63V

3.0 TYPICAL PHASE NOISE PLOT



FIGURE 3-1: Typical Phase Noise @ 25°C, 100 MHz, 3.3V.

4.0 OUTPUT WAVEFORM



FIGURE 4-1: Output Waveform.

5.0 TEST CIRCUIT



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6.0 TIMING DIAGRAMS



FIGURE 6-1: Start-Up Time.



FIGURE 6-2: Enable Time with Pin 1 Configured as Standby (STB).



FIGURE 6-3: Enable Time with Pin 1 Configured as OE.



As shown, the output Enable/Disable in OE mode (pin 1 configured as OE) happens at the clock falling edge while in Standby mode (pin 1 configured as STB) it happens asynchronously.

7.0 SOLDER REFLOW PROFILE





TABLE 7-1: SOLDER REFLOW

MSL 1 @ 250°C Refer to JSTD-020C						
Ramp-Up Rate (200°C to Peak Temp.)	3°C/sec. max.					
Preheat Time 150°C to 200°C	60 to 180 sec.					
Time Maintained above 217°C	60 to 150 sec.					
Peak Temperature	255°C to 260°C					
Time within 5°C of Actual Peak	20 to 40 sec.					
Ramp-Down Rate	–6°C/sec. max.					
Time 25°C to Peak Temperature	8 minutes max.					

8.0 FUNCTIONAL DESCRIPTION

The DSC150x/DSC152x are MEMS-based CMOS oscillators that combine excellent jitter and stability performance at a very low power over a wide range of supply voltage and temperature. The device operates from 2.3 MHz to 170 MHz with 2.5V and 3.3V supply voltage and from 2.3 MHz to 125 MHz with 1.8V supply voltage over -40° C to $+125^{\circ}$ C temperature range. It has four pins and comes in different industry-standard package sizes.

The standard DSC150x/DSC152x comes with standard output drive strength with optional low and high drive strengths (see Table 8-1). Low output drive strength offers slower edge rates for lower EMI interference.

TABLE 8-1:	OUTPUT DRIVE STRENGTH
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Device	CMOS Output Strength
DSC1501/21	LVCMOS Medium drive (2.5V/3.3V)
DSC1502/22	LVCMOS Standard drive (2.5V/3.3V)
DSC1503/23	LVCMOS Low drive (2.5V/3.3V)
DSC1504/24	LVCMOS Low drive (1.8V)
DSC1505/25	LVCMOS Standard drive (1.8V)

Pin 1 can be programmed to implement Enable function (OE) or Standby function (STB).

TABLE 8-2: ENABLE AND STANDBY FUNCTION

Control Pin (Pin 1) Definition							
P/N Function Pin 1 Pin High Low							
DSC150x	Standby	Active	Standby				
DSC152x	Enable/Disable	Enable	Disable				

Users can build the part with their desired output drive strength and pin 1 control pin options by using the ClockWorks Configurator online tool.

9.0 RECOMMENDED BOARD LAYOUT



FIGURE 9-1: Recommended Board Layout.

10.0 PACKAGING INFORMATION

10.1 Package Marking Information



Legend:	XXX Y YY WW SSS @3 * *	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
Note:	In the ever be carried characters the corpor Underbar	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available for customer-specific information. Package may or may not include ate logo. (_) and/or Overbar (⁻) symbol may not be to scale.

4-Lead Very Thin Fine Pitch Land Grid Array (ASA) 2.0 mm x 1.6 mm Package Outline and Recommended Land Pattern (VFLGA)





BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

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4-Lead Very Thin Land Grid Array (AUA) 2.5 mm x 2.0 mm Package Outline and Recommended Land Pattern (VLGA)





REF: Reference Dimension, usually without tolerance, for information purposes only.

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4-Lead Very Thin Dual Flatpack, No Lead Package (JZA) 7 mm x 5 mm x 0.9 mm (VDFN) Package Outline and Recommended Land Pattern with 2.2 mm x 3.5 mm Exposed Pad





4-Lead Very Thin Dual Flatpack, No Lead Package (JZA) - 7x5x0.9 mm Body [VDFN] With 2.2x3.5 mm Exposed Pad

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS					
	Dimension Limits	MIN	MIN NOM				
Number of Terminals	N		004				
Pitch	е		5.08 Ref				
Overall Height	A	0.80	0.80 0.85 0.90				
Standoff	A1	0.00	-	0.05			
Terminal Thickness	A3		0.203 Ref				
Overall Length	D	6.90	7.00	7.10			
Exposed Pad Length	D2	2.10	2.20	2.30			
Overall Width	E	4.90 5.00 5.10					
Exposed Pad Width	E2	3.40 3.50 3.60					
Terminal Width	b	1.35 1.40 1.45					
Terminal Length	1	1 10	1 20	1.30			

Notes:

Pin 1 visual index feature may vary, but must be located within the pin 1 area.
 Package is saw singulated
 Dimensioning and tolerancing per ASME Y14.5M BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

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NOTES:

APPENDIX A: REVISION HISTORY

Revision A (June 2021)

• Initial release of DSC150x/DSC152x as Microchip data sheet DS20006516A.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	X T	X	X	X	2	×	X		-XXXXXXXXX	X
Device	Pin	Drive Strength	Раскаде	Temperature	Star	ollity	Revisio	1 Ou	itput Frequency	Туре
Device:	DSC15:	Low-Pow Oscillato	ver Low-Jitter or	CMOS MEMS		Exa	amples:			
Control Pin:	0 = 2 =	Standby F Enable/Dis	unction (STB sable Functio) n (OE)		a) [50N	DSC1521MI M00000:	_3A-	Pin1 OE, CMOS Lead 2.0 mm x 1. 105°C Temperatu ±20 ppm, 50 MHz	Medium Drive, 4- 6 mm, –40°C to re Range, r, Bulk.
Output Drive Strength:	1 = 2 = 3 = 4 =	LVCMOS I LVCMOS I LVCMOS I LVCMOS I	Medium Drive Standard Driv Low Drive (2. Low Drive (1.	e (2.5V.3.3V) ve (2.5V.3.3V) 5V.3.3V) 8V)		b) [100	DSC1502JI ² 0M0000T:	1A-	Pin1 STB, CMOS Lead 2.5 mm x 2. 85°C Temperature 100 MHz, 1,000 F	Standard Drive, 4- 0 mm, –40°C to e Range, ±50 ppm, Reel.
Package:	5 = A = J =	LVCMOS \$ 7.0 mm x \$ 2.5 mm x \$	Standard Driv 5.0 mm 4-Lea 2.0 mm 4-Lea	ve (1.8V) ad VDFN ad VLGA		Note	e 1: Tape cata used the Sale	e and I log pa d for or device es Offic	Reel identifier only art number descripti rdering purposes a package. Check w ce for package ava	appears in the on. This identifier is nd is not printed on rith your Microchip ilability with the
Temperature:	M = E = I = L = A =	-20°C to + -40°C to + -40°C to + -40°C to +	-70°C (Exten -85°C (Indust -105°C (Exten -125°C (Auto	ad VLGA ded Commercial) trial) nded Industrial) motive)			Таре	e and I	Reel option.	
Frequency Stability:	1 = 2 = 3 =	±50 ppm ±25 ppm ±20 ppm	(
Revision:	A =	Revision A	N N							
Output Frequency	: xMxxxxxx xxMxxxxx xxxMxxxxx	= ≤ 9.999999 = 10.00000 = ≥ 100.0000	9 MHz MHz to 99.99 0 MHz	9999 MHz						
Media Type:	<blank> = T = B =</blank>	Bulk (100/ Bulk in Tul 1,000/Ree 3,000/Ree	Bag) for 2.0 r be for Other F I	mm x 1.6 mm Pack Packages	age					
Please visit the configure the pa	Microchi Irt number s.microchi	p ClockWo for custon ip.com/tim	orks Confi nized frequ ing	igurator® web uency select se	site to ttings.					

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ISBN: 978-1-5224-8489-9

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DSC1525MI2A-25M00000T	DSC1502JA3A-156M2500	DSC1502JA3A-156M2500T	DSC1502MI1A-4M096000
DSC1502MI1A-4M096000T	DSC1522JA2A-33M33333	DSC1522JA2A-33M33333T	DSC1522JI2A-33M33333
DSC1522JI2A-33M33333T	DSC1525MI2A-33M33333	DSC1525MI2A-33M33333T	DSC1502AI3A-100M0000
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DSC1502AI3A-156M2500T	DSC1502AI3A-24M00000	DSC1502AI3A-24M00000T	DSC1502AI3A-26M00000
DSC1502AI3A-26M00000T	DSC1502AI3A-32M00000	DSC1502AI3A-32M00000T	DSC1502AI3A-48M00000
DSC1502AI3A-48M00000T	DSC1502AI3A-4M000000	DSC1502AI3A-4M000000T	DSC1502AI3A-66M66670
DSC1502AI3A-66M66670T	DSC1502AI3A-8M000000	DSC1502AI3A-8M000000T	DSC1505AI3A-100M0000
DSC1505AI3A-100M0000T	DSC1505AI3A-125M0000	DSC1505AI3A-125M0000T	DSC1505AI3A-24M00000
DSC1505AI3A-24M00000T	DSC1505AI3A-26M00000	DSC1505AI3A-26M00000T	DSC1505AI3A-32M00000
DSC1505AI3A-32M00000T	DSC1505AI3A-48M00000	DSC1505AI3A-48M00000T	DSC1505AI3A-4M000000
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